

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## In re Application of:

Sandhu et. al.

**Serial No.:** 10/642,705

**Filed:** August 18, 2003

For: PROCESS FOR GROWING A DIELECTRIC LAYER ON A SILICON CONTAINING SURFACE USING A

MIXTURE OF N<sub>2</sub>O AND O<sub>3</sub>

Confirmation No.: 4361

Examiner: T. Meeks

Group Art Unit: 1762

Attorney Docket No.: 2269-3980.3US

(92-0094.02/US)

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 10, 2004

Date

Deborah L. Hendricks

Name (Type/Print)

## AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of June 10, 2004, whose initial period of response is set to expire on September 10, 2004.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.